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**CERTIFICATE OF MAILING PURSUANT TO 37 C.F.R. § 1.8**

I hereby certify that this Office Action Response, pursuant to 37 C.F.R. § 1.8, is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on:



By: *Ski O*

Signature of Person Depositing First Class Mail

**IN THE UNITED STATES PATENT  
AND TRADEMARK OFFICE**

**PATENT**

Applicant:	Sugiyama et al.	Docket No.:	30598.0004
Serial No.:	08/960,431	Art Unit:	3723
Filed:	October 29, 1997	Examiner:	Nguyen, G.
Title	<b>FLATTENING METHOD AND FLATTENING APPARATUS OF A SEMICONDUCTOR DEVICE</b>	Confirmation No.:	5997

**RESPONSE**

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In response to the Office Action dated March 22, 2004, of which period of time for Response is extended two (2) months to and including July 22, 2004, please consider the following.

**REMARKS**

Applicants hereby enclose Supplemental Declarations in accordance with 37 C.F.R. 1.175(b)(1) which have been executed by the inventors of the subject application.

**CONCLUSION**

Submittal of the attached Supplemental Declarations overcomes the Examiner's rejection under 37 U.S.C. 251. Subsequently, Applicants request a Notice of Allowance be issued in the captioned matter. The Examiner is invited to telephone the undersigned at (602) 382-6337 at the Examiner's convenience, if there are any questions or anything further is needed.

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